

# STARPOWER

**SEMICONDUCTOR****IGBT**

## GD150HFK120C2S

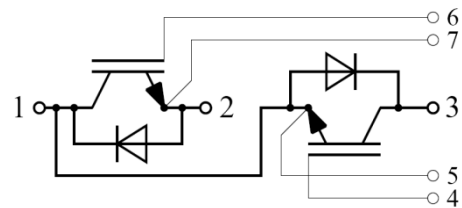
**Molding Type Module****1200V/150A 2 in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction and switching loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

### Features

- NPT IGBT technology
- Low switching loss
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

**Absolute Maximum Ratings**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Description	GD150HFK120C2S	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^\circ\text{C}$ @ $T_C=80^\circ\text{C}$	260 150	A
$I_{CM}$	Pulsed Collector Current $t_p=1\text{ms}$	300	A
$I_F$	Diode Continuous Forward Current @ $T_C=80^\circ\text{C}$	150	A
$I_{FM}$	Diode Maximum Forward Current $t_p=1\text{ms}$	300	A
$P_D$	Maximum Power Dissipation @ $T_j=150^\circ\text{C}$	1190	W
$T_{jmax}$	Maximum Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^\circ\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	2500	V
Mounting Torque	Power Terminal Screw:M6 Mounting Screw:M6	2.5 to 5.0 3.0 to 5.0	N.m

**Electrical Characteristics of IGBT**  $T_C=25^\circ\text{C}$  unless otherwise noted**Off Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}$ , $V_{GE}=0\text{V}$ , $T_j=25^\circ\text{C}$			5.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}$ , $V_{CE}=0\text{V}$ , $T_j=25^\circ\text{C}$			400	nA

**On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=2.0\text{mA}$ , $V_{CE}=V_{GE}$ , $T_j=25^\circ\text{C}$	4.8	5.7	6.3	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=150\text{A}$ , $V_{GE}=15\text{V}$ , $T_j=25^\circ\text{C}$		2.15	2.60	V
		$I_C=150\text{A}$ , $V_{GE}=15\text{V}$ , $T_j=125^\circ\text{C}$		2.65		

**Switching Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=150A,$ $R_G=5.6\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		334		ns
$t_r$	Rise Time			88		ns
$t_{d(off)}$	Turn-Off Delay Time			429		ns
$t_f$	Fall Time			171		ns
$E_{on}$	Turn-On Switching Loss			9.08		mJ
$E_{off}$	Turn-Off Switching Loss			11.5		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=150A,$ $R_G=5.6\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		337		ns
$t_r$	Rise Time			89		ns
$t_{d(off)}$	Turn-Off Delay Time			438		ns
$t_f$	Fall Time			226		ns
$E_{on}$	Turn-On Switching Loss			12.3		mJ
$E_{off}$	Turn-Off Switching Loss			15.9		mJ
$C_{ies}$	Input Capacitance	$V_{CE}=30V, f=1MHz,$ $V_{GE}=0V$		/		nF
$C_{oes}$	Output Capacitance			/		nF
$C_{res}$	Reverse Transfer Capacitance			/		nF
$I_{SC}$	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		900		A
$L_{CE}$	Stray Inductance				20	nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal To Chip			0.35		m $\Omega$

**Electrical Characteristics of DIODE**  $T_C=25^\circ C$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
$V_F$	Diode Forward Voltage	$I_F=150A$	$T_j=25^\circ C$		1.65	2.15	V
			$T_j=125^\circ C$		1.65		
$Q_r$	Recovered Charge	$I_F=150A,$	$T_j=25^\circ C$		14.5		$\mu C$
			$T_j=125^\circ C$		27.0		
$I_{RM}$	Peak Reverse Recovery Current	$V_R=600V,$ $R_G=5.6\Omega,$	$T_j=25^\circ C$		102		A
			$T_j=125^\circ C$		142		
$E_{rec}$	Reverse Recovery Energy	$V_{GE}=-15V$	$T_j=25^\circ C$		6.92		mJ
			$T_j=125^\circ C$		13.2		

**Thermal Characteristics**

<b>Symbol</b>	<b>Parameter</b>	<b>Typ.</b>	<b>Max.</b>	<b>Units</b>
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.105	K/W
$R_{\theta JC}$	Junction-to-Case (per DIODE)		0.261	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.035		K/W
Weight	Weight of Module	300		g

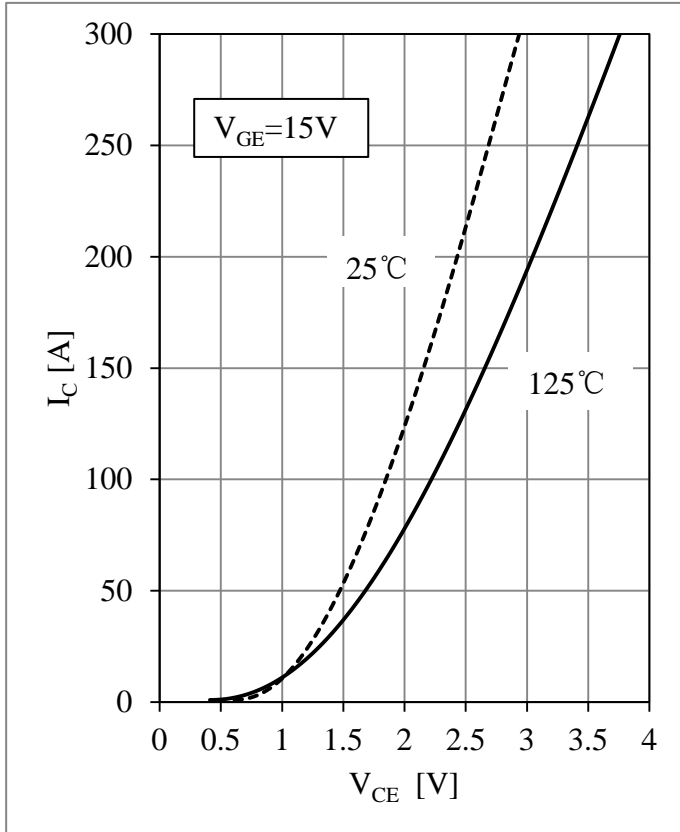


Fig 1. IGBT Output Characteristic

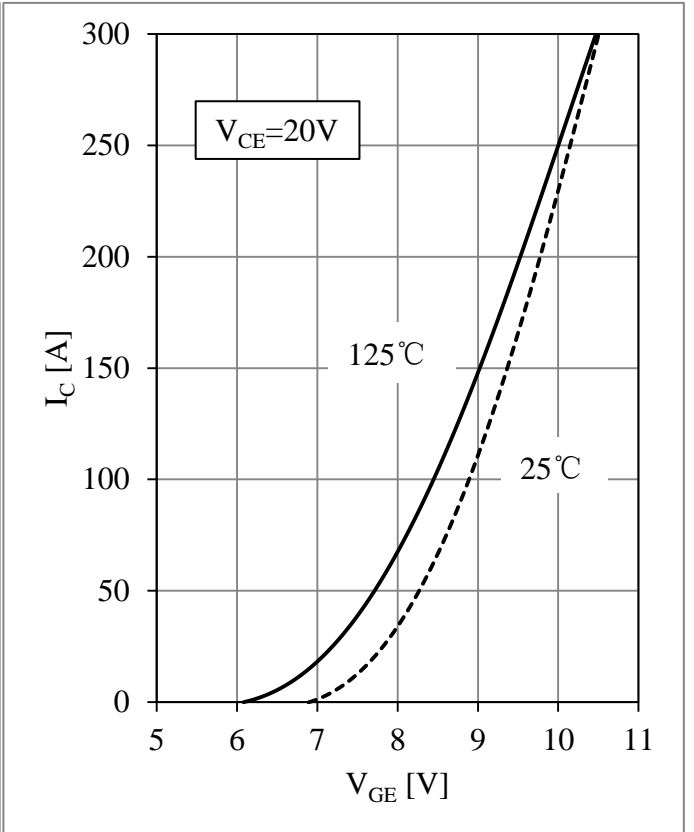


Fig 2. IGBT Transfer Characteristic

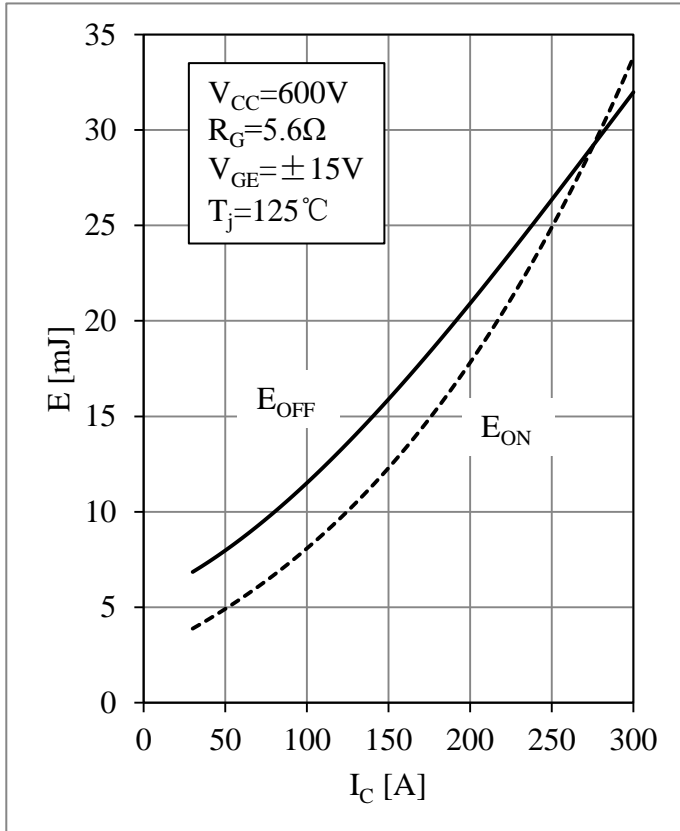


Fig 3. IGBT Switching Loss vs.  $I_C$

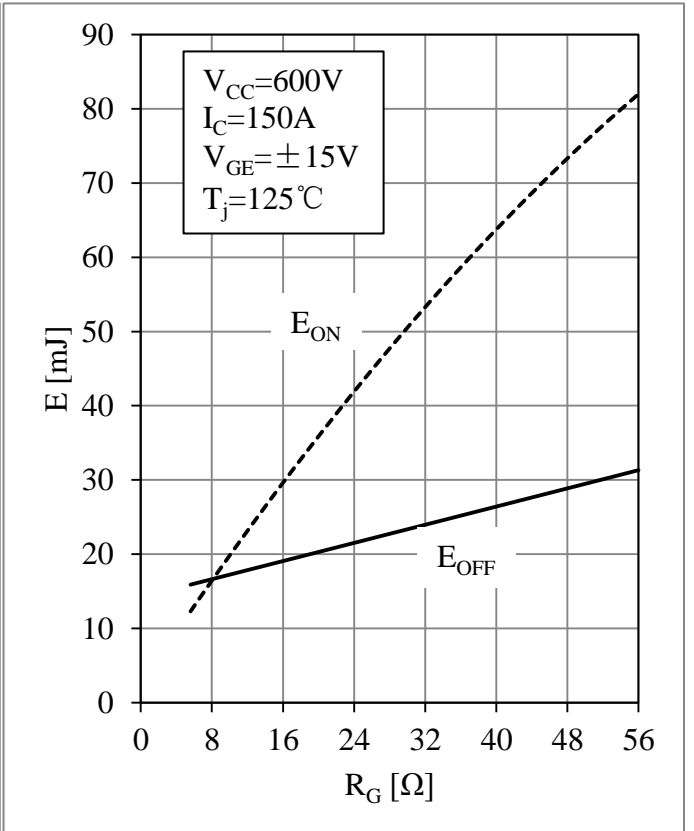


Fig 4. IGBT Switching Loss vs.  $R_G$

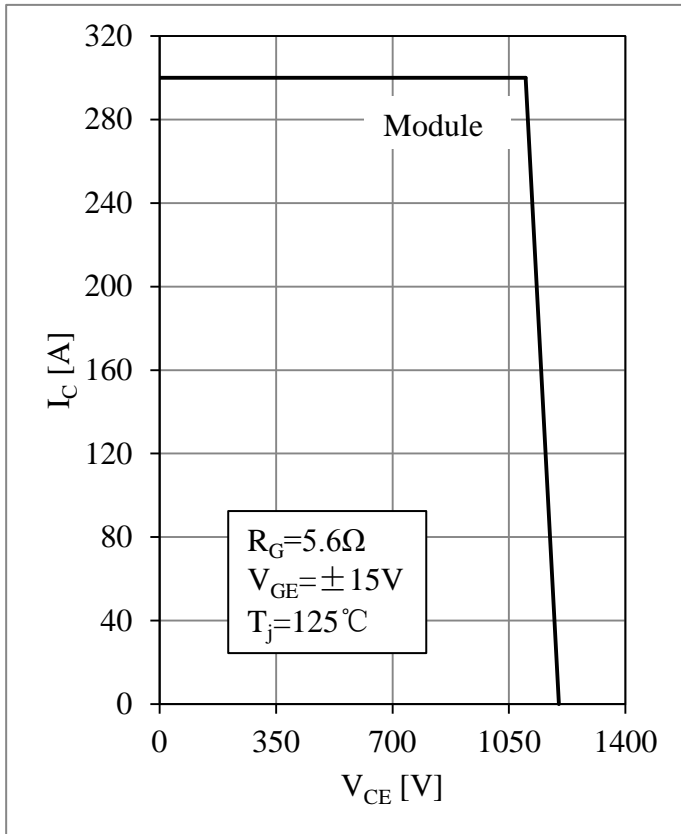


Fig 5. RBSOA

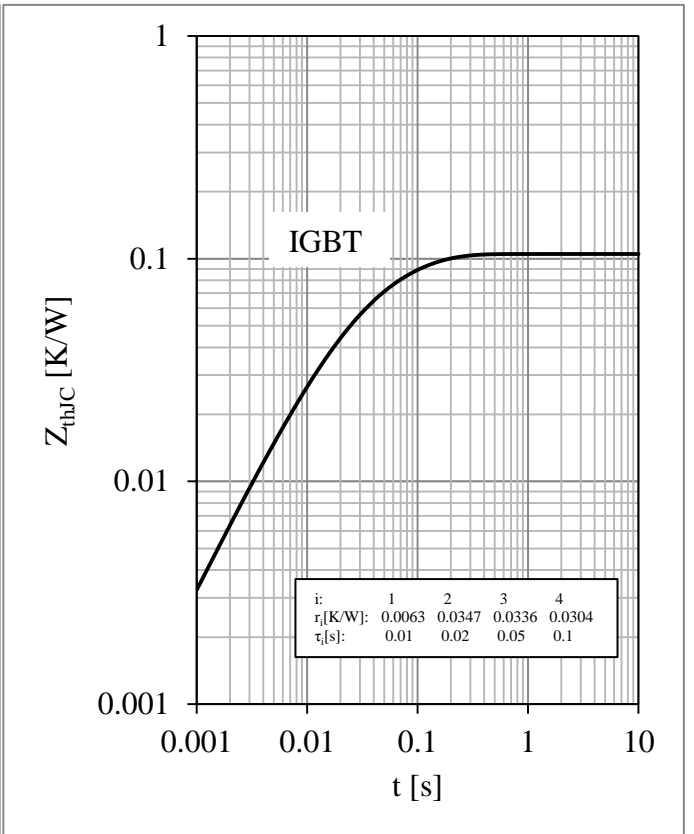


Fig 6. IGBT Transient Thermal Impedance

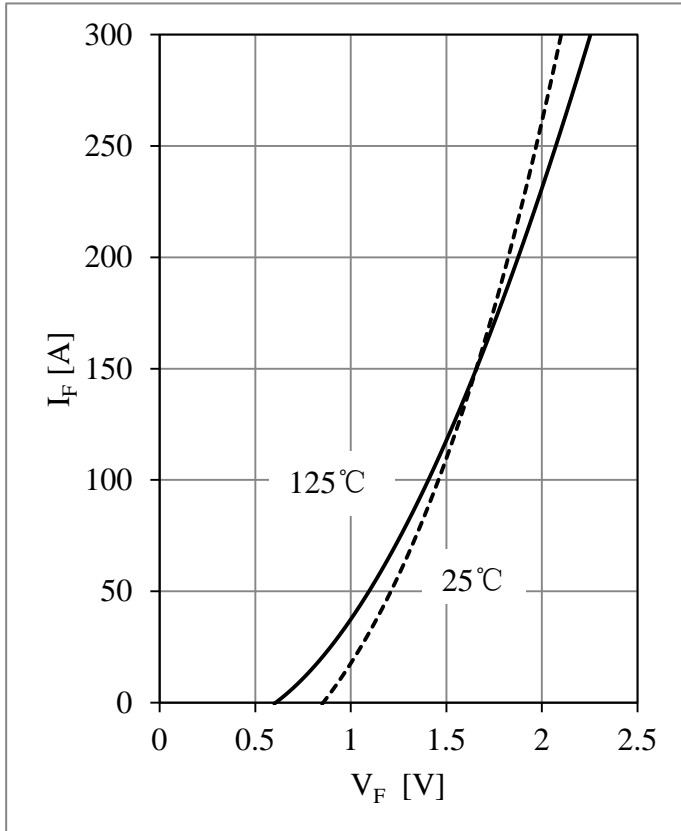


Fig 7. Diode Forward Characteristic

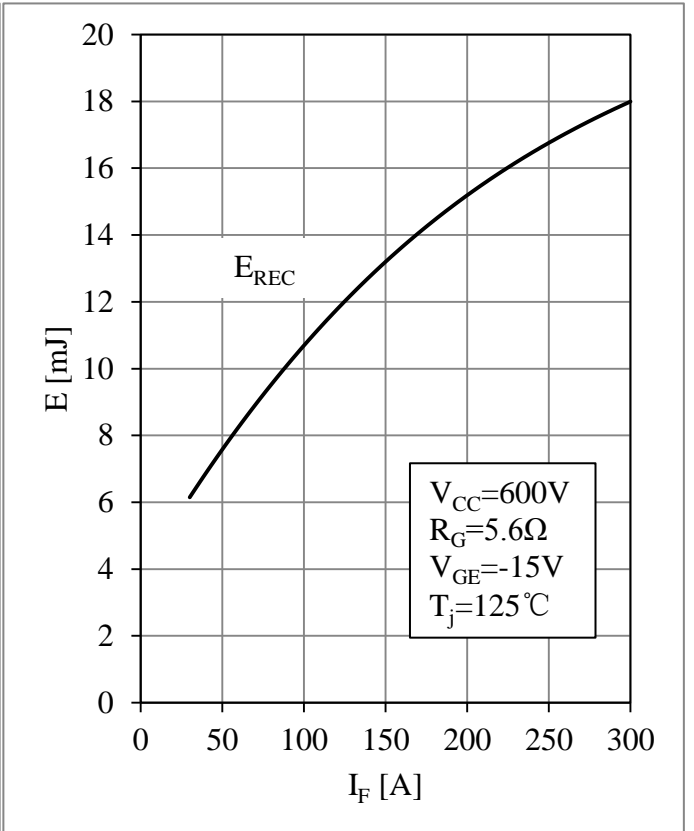


Fig 8. Diode Switching Loss vs.  $I_F$

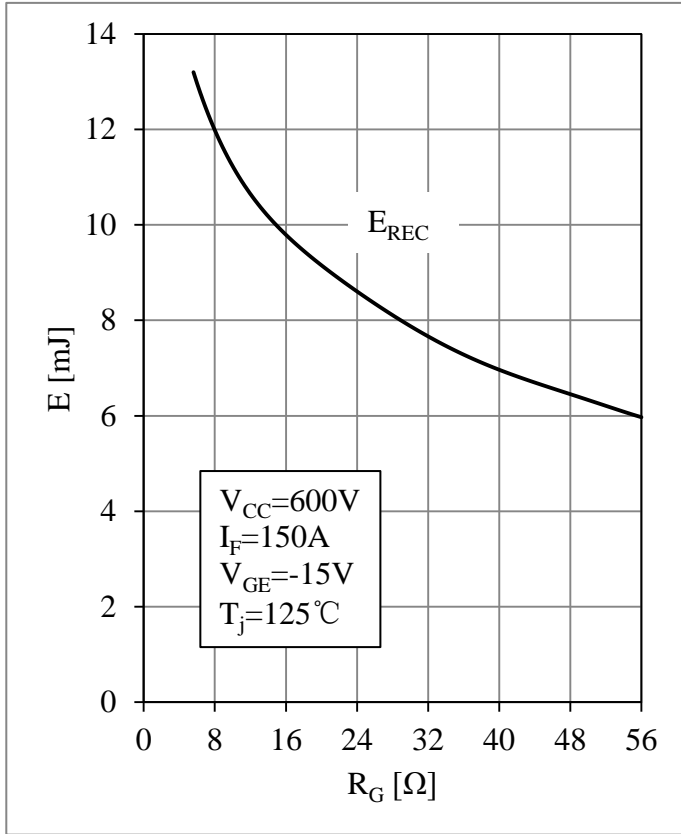


Fig 9. Diode Switching Loss vs.  $R_G$

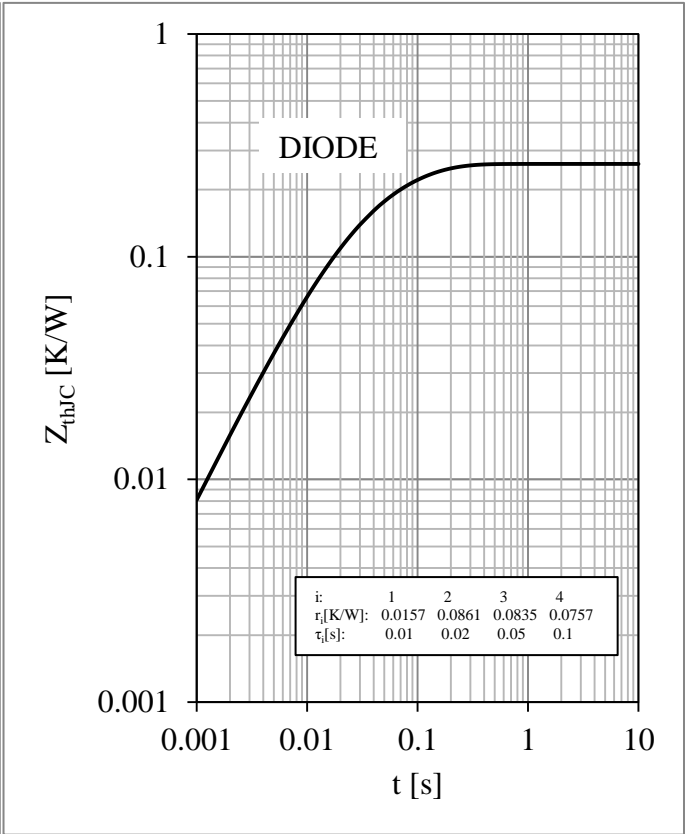
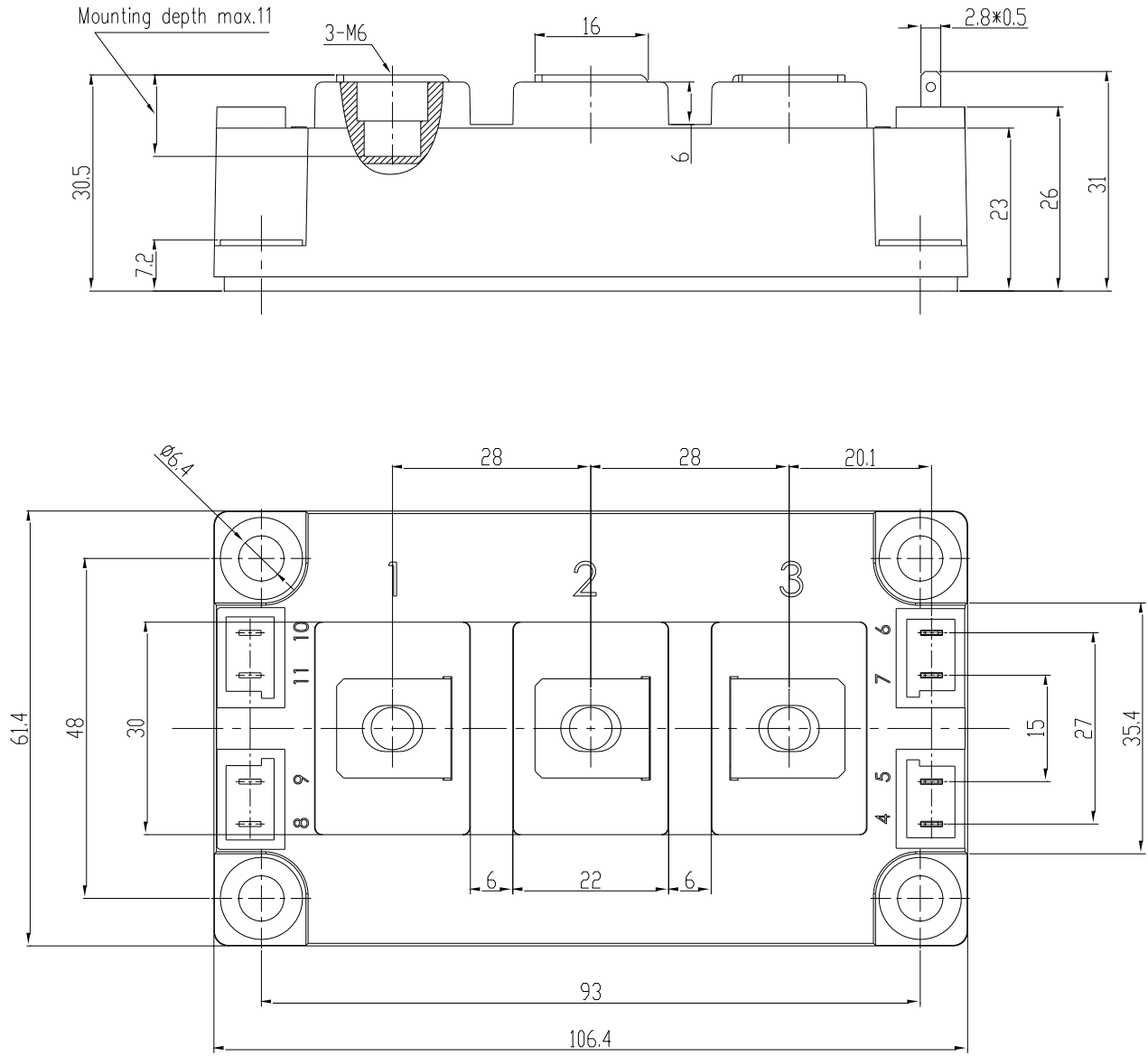


Fig 10. Diode Transient Thermal Impedance

**Package Dimensions**

Dimensions in Millimeters





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